



November 29<sup>th</sup>, 2011

To whom it may concern:

Dear Customer,

SpanSion LLC has announced the consolidation of package assembly and electrical testing of Thin Small Outline Package (TSOP) products from the SpanSion Kuala Lumpur facility to the SpanSion Bangkok facility. After this consolidation, SpanSion Kuala Lumpur facility will not be available for TSOP assembly and electrical testing. The Bangkok facility has already been qualified for high volume assembly and testing of TSOP products using identical equipment and packaging materials.

SpanSion employs a copy exact process for the final manufacturing sites. Bangkok and Kuala Lumpur use the same equipment, materials and control processes. The same specifications are used to control both factories. There is no difference in form fit and function between the products produced in the two factories.

SpanSion has long recognized the vital importance of high quality in our products. We will continue to support you with the same manufacturing processes.

Sincerely,

A handwritten signature in black ink, appearing to read "P. Claverie", with a long horizontal stroke extending to the right.

Pierre Claverie,  
Senior Vice President  
Supply Chain & Final Operations